# Board Design

Andreas Sakellariou, Saverio Citraro

FTK-IAPP Executive Board – Pisa, 27 June, 2013

## Man Power for PCB design

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Andreas Sakellariou, Secondment from Prisma Electronic to Pisa
 April, May 2013



• Saverio Citraro, FTK-IAPP Researcher, UNIPI Fellow.



• Pierluigi Luciano, Master Degree Student University of Pisa.

### About new Boards

• AMBSLP: Associative Memory Board Serial Link Processor (Designed by Andreas Sakelariou, Saverio Citraro, CERN)

• MiniLAMBSLP: Little Associative Memory Board Serial Link Processor for Miniasic (Designed by Pierluigi Luciano)

• LAMBSLP: Little Associative Memory Board Serial Link Processor for Amchip05 (Designed by Saverio Citraro)

#### AMBSLP

#### Main new features:

• All data paths are differential serial link 2 Gbit/s.

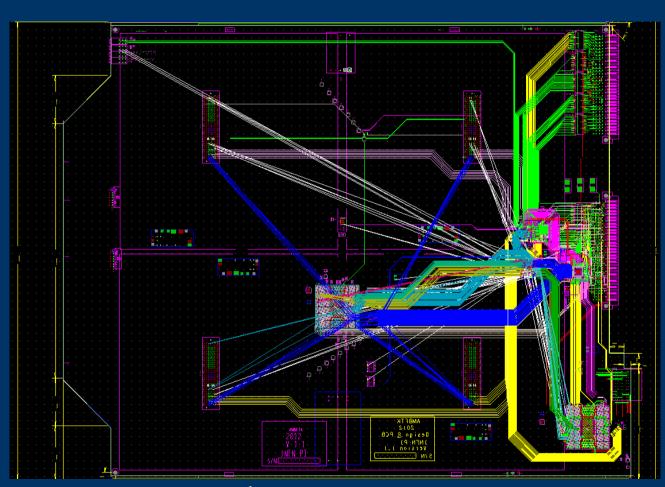
• All clocks are differential LVDS.

• There are only 2 big FPGAs (Artix-7 1156 pads) for data distribution.

#### AMBSLP

#### Work plan:

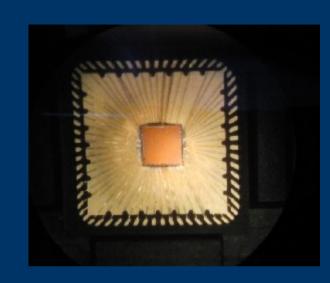
- → April and May 2013: start schematic editing and routing.
- → Now: electronic group at CERN finalizing layout routing.
- → End of June 2013: submission of the board for production.



PCB layout at 21 June, 2013

#### MiniLAMBSLP

#### Main features:

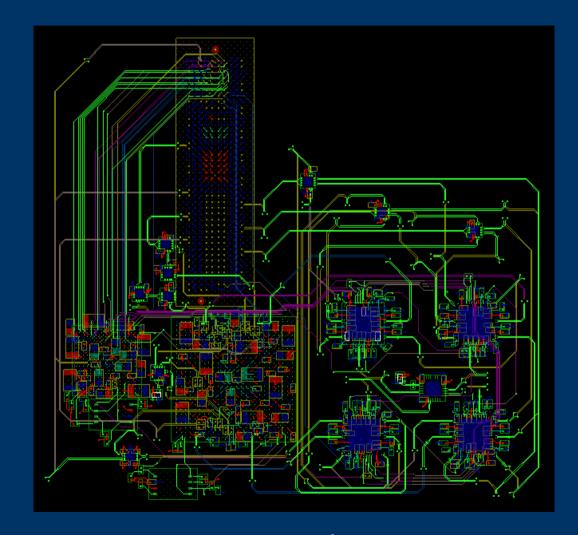


- A quarter of final LAMBSLP, with 4 chips.
- Designed for MiniASIC (little AMchip to test SerDes).
- Designed to test the MiniASIC and new data-path (LVDS serial fanout).

### **MiniLAMBSLP**

#### Work plan:

- → May and June 2013: design of schematic and routing.
- → Now: wait of
   MiniASIC chip test
   result (in Milan).
   Then submission of
   the board for
   production.

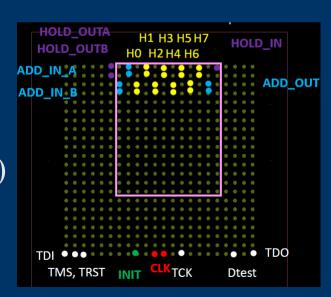


Final PCB layout

#### LAMBSLP

#### Main new features:

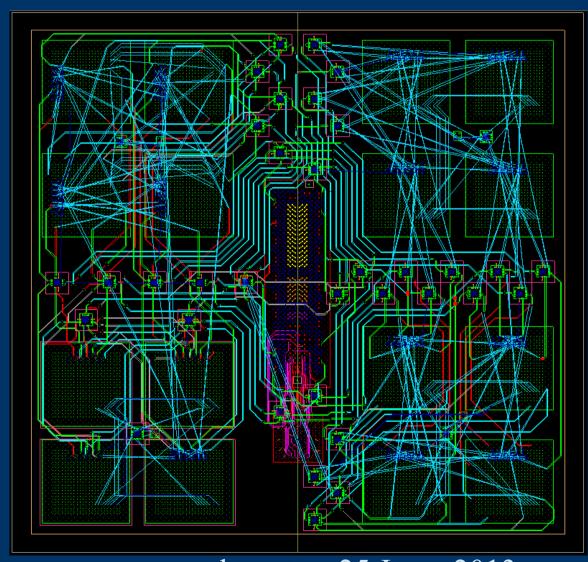
- All data paths are differential serial link 2 Gbit/s.
- New high speed and high power connector.
- Designed for AMChip05 (BGA 23mmx23mm)



#### LAMBSLP

#### Work plan:

- → June 2013: start the schematic editing and routing.
- → Now: work in progress on PCB-layout.
- → After the test of
  MiniLAMBSLP (with
  MiniAsic chip)
  submission the board for
  production.



PCB layout at 25 June, 2013

# Next steps

→ End of June submission of AMBSLP.

→ In July mounting component on AMBSLP.

→ End of July send AMBSLP in Prisma Electronic for tests.

→ After test results on Amchip05 submission LAMBSLP.

### Conclusions

Satisfied about PCB design result

• Useful exchange of knowledge

• We are continuing the job with enthusiasm

# Thanks!

